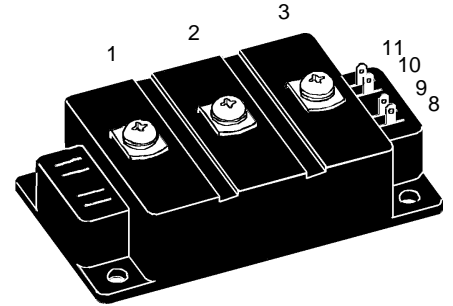
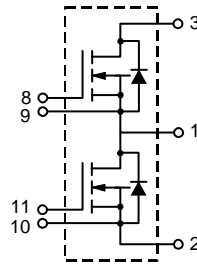


Dual Power HiPerFET™ Module

VMM 300-03F
 $V_{DSS} = 300\text{ V}$
 $I_{D25} = 290\text{ A}$
 $R_{DS(on) \text{ typ.}} = 7.4\text{ m}\Omega$

Phaseleg Configuration
 High dv/dt, Low t_{rr} , HDMOS™ Family



| Symbol | Conditions | Maximum Ratings | |
|---------------|--|--|------------------------|
| V_{DSS} | $T_J = 25^\circ\text{C to } 150^\circ\text{C}$ | 300 | V |
| V_{DGR} | $T_J = 25^\circ\text{C to } 150^\circ\text{C}; R_{GS} = 10\text{ k}\Omega$ | 300 | V |
| V_{GS} | Continuous | ± 20 | V |
| V_{GSM} | Transient | ± 30 | V |
| I_{D25} | $T_C = 25^\circ\text{C}$ | 290 | A |
| I_{D80} | $T_C = 80^\circ\text{C}$ | 220 | A |
| I_{DM} | $T_C = 25^\circ\text{C}; t_p = 10\text{ }\mu\text{s}$ ① | 1160 | A |
| P_D | $T_C = 25^\circ\text{C}$ | 1500 | W |
| T_J | | -40 ... +150 | $^\circ\text{C}$ |
| T_{JM} | | 150 | $^\circ\text{C}$ |
| T_{stg} | | -40 ... +125 | $^\circ\text{C}$ |
| V_{ISOL} | 50/60 Hz $I_{ISOL} \leq 1\text{ mA}$ | $t = 1\text{ min}$ $t = 1\text{ s}$ | 3000 3600 V~ |
| M_d | Mounting torque (M6) Terminal connection torque (M5) | 2.25-2.75/20-25 2.5-3.7/22-33 | Nm/lb.in. Nm/lb.in. |
| Weight | typical including screws | 250 | g |

Features

- Low $R_{DS(on)}$ HDMOS™ process
- International standard package
- Low package inductance for high speed switching
- Kelvin Source contact for easy drive
- Direct Copper Bonded Al_2O_3 ceramic base plate

Applications

- AC motor speed control for electric vehicles
- DC servo and robot drives
- Switched-mode and resonant-mode power supplies
- DC choppers

Advantages

- Easy to mount
- Space and weight savings
- High power density
- Low losses

| Symbol | Conditions | Characteristic Values ($T_J = 25^\circ\text{C}$, unless otherwise specified) | | |
|--------------|--|---|------|---|
| | | min. | typ. | max. |
| V_{DSS} | $V_{GS} = 0\text{ V}, I_D = 12\text{ mA}$ | 300 | | V |
| $V_{GS(th)}$ | $V_{DS} = 20\text{ V}, I_D = 30\text{ mA}$ | 2 | | V |
| I_{GSS} | $V_{GS} = \pm 20\text{ V DC}, V_{DS} = 0$ | | | $\pm 500\text{ nA}$ |
| I_{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0\text{ V}$ | | | $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ 0.5 mA 8 mA |
| $R_{DS(on)}$ | $V_{GS} = 10\text{ V}, I_D = 0.5 \cdot I_{D25}$ Pulse test, $t \leq 300\text{ }\mu\text{s}$, duty cycle $d \leq 2\%$ | | 7.4 | 8.6 m Ω |

① Additional current limitation by external leads

IXYS reserves the right to change limits, test conditions and dimensions.

| Symbol | Conditions | Characteristic Values | | |
|---------------------------|--|---|------|----------|
| | | (T _J = 25°C, unless otherwise specified) | | |
| | | min. | typ. | max. |
| g_{fs} | V _{DS} = 10 V; I _D = 0.5 • I _{D25} pulsed | | 280 | S |
| C_{iss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 40 | nF |
| C_{oss} | | | 7.2 | nF |
| C_{rss} | | | 2.8 | nF |
| t_{d(on)} | V _{GS} = 10 V, V _{DS} = 0.5 • V _{DSS} , I _D = 0.5 • I _{D25} R _G = 1 Ω | | 200 | ns |
| t_r | | | 400 | ns |
| t_{d(off)} | | | 400 | ns |
| t_f | | | 150 | ns |
| Q_g | V _{GS} = 10 V, V _{DS} = 150 V, I _D = 150 A | | 1440 | nC |
| Q_{gs} | | | 240 | nC |
| Q_{gd} | | | 720 | nC |
| R_{thJC} | | | | 0.08 K/W |
| R_{thJS} | with heat transfer paste | | 0.12 | K/W |

| Symbol | Conditions | Characteristic Values | | |
|-----------------------|--|---|------|--------|
| | | (T _J = 25°C, unless otherwise specified) | | |
| | | min. | typ. | max. |
| I_S | V _{GS} = 0 V, T _C = 25°C, T _J = T _{JM} | | | 290 A |
| I_{SM} | ② | | | 1160 A |
| V_{SD} | I _F = 300 A, V _{GS} = 0 V, Pulse test, t ≤ 300 μs, duty cycle d ≤ 2 % | | 0.9 | 1.1 V |
| t_{rr} | I _F = 300 A, -di/dt = 400 A/μs, V _{DS} = 0.5 • V _{DSS} | | 300 | ns |

② Additional current limitation by external leads

